

ENGINEERING	PRODUCT SPECIFICATION	SPEC.NO.: SPCE008A
DEPT.	For Mini Circular DIN Connector of system CE56	PAGE: 1/3

1. SCOPE:

This specification contains the test requirement of subject connectors when tested under the condition and below standards base on CviLux test procedure

2. APPLICABLE STANDARDS:

MIL - STD - 202 Methods for test of connectors for electronic equipment
MIL - STD - 1344 Test methods for electrical connectors

3. APPLICABLE SERIES NO.: **CE56 Series**

4. SHAPE, CONSTRUCTION AND DIMENSIONS

See attached drawings

5. MATERIALS

See attached drawings

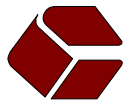
6. ACCOMMODATED P.C. BOARD

6.1 Thickness: 1.6 mm (.063")

6.2 P.C. Board Layout: See attached drawings



REVIEWED : Alex APPROVED : David VERIFIED : Sun .



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7. ELECTRICAL PERFORMANCE:

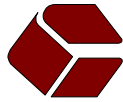
	ITEM	TEST CONDITION	REQUIREMENT
7.1	Rated current and voltage		1A 100V AC (r.m.s.) 2A 12V DC
7.2	Contact resistance	Dry circuit of DC 20 mV max. , 100 mA max.	Less than 30 mΩ
7.3	Dielectric strength	When applied AC 500 V 1 minute between adjacent terminal	No change
7.4	Insulation resistance	When applied DC 500 V between adjacent terminal or ground	More than 500 MΩ

8. MECHANICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
8.1	Contact retaining force in insulator	Retention speed 25± 3 mm per minute from housing	More than 1.8 Kgf
8.2	Mating force	Mating speed 25 mm/minute	4.5 Kgf max.
8.3	Unmating force	Unmating speed 25 mm/minute	0.9 Kgf ~ 3.0 Kgf
8.4	Durability	Connector shall be subject to 100 cycles of insertion and withdrawal	Contact resistance: Less than twice of initial

9. ENVIRONMENTAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
9.1	Temperature rise	Then carried the rated current	30°C max.
9.2	Vibration	1.5 mm 10-55-10 HZ/minute each 2 hours for X,Y and Z directions	Appearance: No damage Discontinuity: 1 micro second max.
9.3	Solder ability	Soldering time: 5 ± 0.5 second Soldering pot: 230 ± 5°C	Minimum: 90% of immersed area
9.4	Resistance to soldering heat	Soldering time: 5 ± 0.5 second Soldering pot: 260 ± 5°C	No damage
9.5	Heat aging	105±2°C, 96 hours	No damage
9.6	Humidity	40±2°C, 90-95% RH, 96 hours measurement must be taken within 30 min. after tested	Appearance: No damage Contact resistance: Less than twice of initial Dielectric strength: To pass para 7-3



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	ITEM	TEST CONDITION	REQUIREMENT
9.7	Temperature cycling	One cycle consists of : (1)-55 $\begin{matrix} +0 \\ -3 \end{matrix}$ °C , 30 min. (2)Room temp. 10-15 min. (3) 85 $\begin{matrix} +3 \\ -0 \end{matrix}$ °C , 30 min. (4)Room temp. 10-15 min.	Appearance: No damage Contact resistance: Less than twice of initial
9.8	Salt spray	Temperature: 35±3°C Solution: 5±1% Spray time: 48±4 hours Measurement must be taken after water rinse	Appearance: No damage Contact resistance: Less than twice of initial

10. AMBIENT TEMPERATURE RANGE: -40 to + 105°C